Power MOSFET

30 V, 19 A, Single N-Channel, SOIC-8 FL

Features

- Fast Switching Times
- Low Gate Charge
- Low R_{DS(on)}
- Low Inductance SOIC-8 Package
- These are Pb-Free Devices

Applications

- Notebooks, Graphics Cards
- DC-DC Converters
- Synchronous Rectification

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	30	V
Gate-to-Source Voltage			V_{GS}	±20	V
Continuous Drain Current	Steady State	T _A = 25°C	I _D	11.5	Α
(Note 1)		T _A = 85°C		8.0	
	t ≤ 10 s	T _A = 25°C		19	
Power Dissipation (Note 1)	Steady State	T _A = 25°C	P _D	2.2	W
	t ≤ 10 s			6.25	
Continuous Drain Current		T _A = 25°C	I _D	7.8	Α
(Note 2)	Steady	T _A = 85°C		5.6	
Power Dissipation (Note 2)	State	T _A = 25°C	P _D	1.0	W
Pulsed Drain Current	t _p ≤	t _p ≤ 10 μs		58	Α
Operating Junction and Storage Temperature			T _J , T _{STG}	-55 to 150	°C
Source Current (Body Diode)			I _S	6.25	Α
Single Pulse Drain-to-Source Avalanche Energy. V_{DD} = 25 V, V_{GS} = 10 V, I_{PK} = 7.0 A, L = 10 mH, R_G = 25 Ω			E _{AS}	245	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	56.5	°C/W
Junction-to-Ambient – t ≤ 10 s (Note 1)	$R_{\theta JA}$	20	
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	124	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

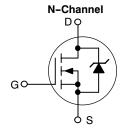
- Surface-mounted on FR4 board using 1 in sq pad size
 (Cu area = 1.127 in sq [1 oz] including traces).
- Surface-mounted on FR4 board using the minimum recommended pad size (Cu area = 0.412 in sq).



ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max		
30 V	7.3 mΩ @ 10 V	19 A		
30 V	10.1 mΩ @ 4.5 V	1074		





D S Q 4708N S AYWW

MARKING DIAGRAM & PIN ASSIGNMENT

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SOIC-8 FLAT LEAD CASE 488AA STYLE 1

Α

08N = Specific Device Code = Assembly Location

Y = Year WW = Work Week ■ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

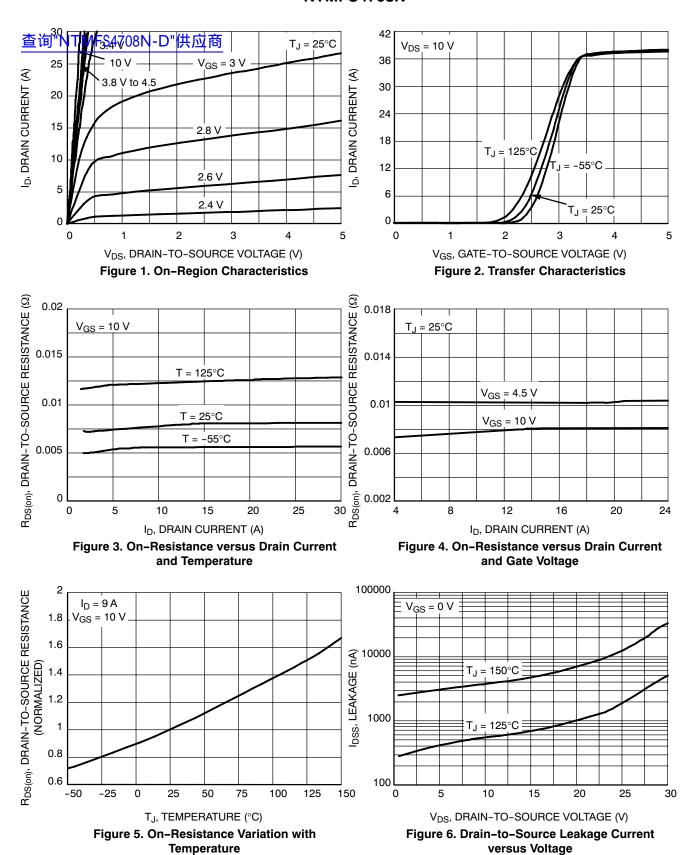
Device	Package	Shipping [†]			
NTMFS4708NT1G	SOIC-8 FL (Pb-Free)	1500 / Tape & Reel			
NTMFS4708NT3G	SOIC-8 FL (Pb-Free)	5000 / ape & Reel			

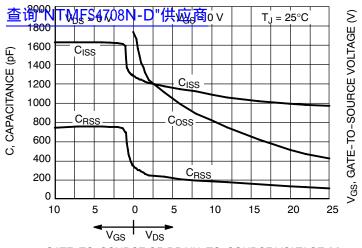
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition	on	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•		•		•	-	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				10		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}		T _J = 25°C			1.0	μΑ
		$V_{GS} = 0 \text{ V}, V_{DS} = 24 \text{ V}$	T _J = 125°C			50	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} =	±20V			±100	nA
ON CHARACTERISTICS (Note 3)	•		•		•	•	•
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 2$	250 μΑ	1.0		2.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				5.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D =	11.5 A		7.3	10	mΩ
		V _{GS} = 4.5 V, I _D =	9.5 A		10.1	14	
Forward Transconductance	9FS	V _{DS} = 15 V, I _D = 11.5 A			23		S
CHARGES, CAPACITANCES AND GA	TE RESISTAN	NCE	L				II.
Input Capacitance	C _{ISS}				970		pF
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 24 V			440		
Reverse Transfer Capacitance	C _{RSS}				115		
Total Gate Charge	Q _{G(TOT)}				10	15	nC
Threshold Gate Charge	Q _{G(TH)}	1			1.3		1
Gate-to-Source Charge	Q _{GS}	$V_{GS} = 4.5 \text{ V}, V_{DS} = 15 \text{ V}; I_D = 11.5 \text{ A}$			2.6		1
Gate-to-Drain Charge	Q_{GD}	1			4.8		1
Gate Resistance	R_{G}				1.95		Ω
SWITCHING CHARACTERISTICS (No	ote 4)		•		•	•	·
Turn-On Delay Time	t _{d(on)}				6.7		ns
Rise Time	t _r	Vgs = 10 V. Vnn = 15 \	/. In = 1.0 A.		4.3		1
Turn-Off Delay Time	t _{d(off)}	V_{GS} = 10 V, V_{DD} = 15 V, I_{D} = 1.0 A, R_{G} = 3.0 Ω			20		
Fall Time	t _f				16		
DRAIN-SOURCE DIODE CHARACTE	RISTICS					•	
Forward Diode Voltage	V _{SD}		T _J = 25°C		0.78	1.0	V
		$V_{GS} = 0 \text{ V}, I_S = 6.25 \text{ A}$ $T_J = 125^{\circ}\text{C}$	T _J = 125°C		0.60		
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V, } d_{IS}/d_t = 100 \text{ A/}\mu\text{s,}$ $I_S = 6.25 \text{ A}$			32		ns
Charge Time	ta				15.5		1
Discharge Time	t _b				16.5		1
Reverse Recovery Charge	Q _{RR}				24		nC

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.





GATE-TO-SOURCE OR DRAIN-TO-SOURCE VOLTAGE (V)

Figure 7. Capacitance Variation

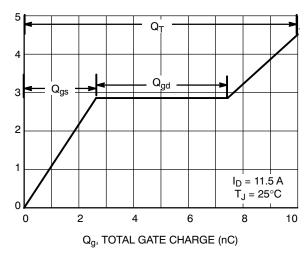


Figure 8. Gate-to-Source and Drain-to-Source Voltage versus Total Charge

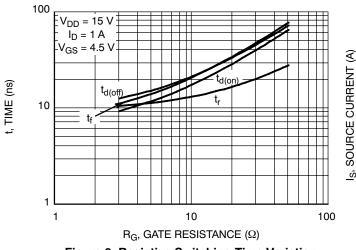


Figure 9. Resistive Switching Time Variation versus Gate Resistance

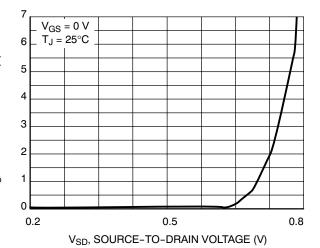


Figure 10. Diode Forward Voltage versus Current

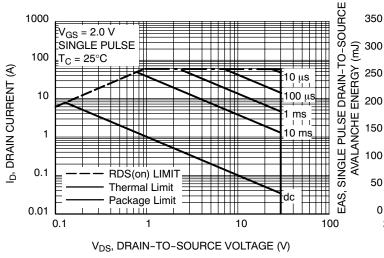
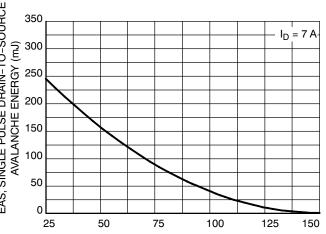


Figure 11. Maximum Rated Forward Biased Safe Operating Area



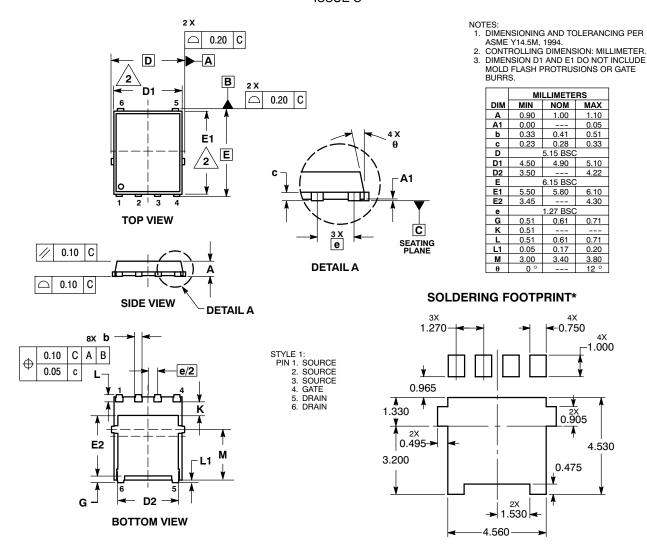
T_J, STARTING JUNCTION TEMPERATURE (°C)

Figure 12. Maximum Avalanche Energy versus Starting Junction Temperature

查询"NTMFS4708N-D"供应商

PACKAGE DIMENSIONS

DFN6 5x6, 1.27P (SO8 FL)CASE 488AA-01 ISSUE C



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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